TinyLogic UHS Dual Buffer (Open-Drain Outputs)

Description

The NC7WZ07 is a dual buffer with open-drain outputs from ON Semiconductor's Ultra-High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive, while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over a very broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} range. The inputs and outputs are high impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 5.5 V independent of V_{CC} operating voltage.

Features

- Ultra-High Speed: t_{PZL} 2.3 ns (Typical)
- High I_{OL} Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.50 V
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPakTM Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

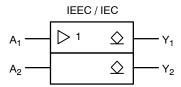


Figure 1. Logic Symbol



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SC-88 CASE 419AD-01



D3. Z07 ΚK

= Specific Device Code

XY Ζ

= 2-Digit Lot Run Traceability Code = 2-Digit Date Code Format

= Assembly Plant Code = Year Coding Scheme = Plant Code Identifier = Die Run Code

= Eight-Week Datacoding Scheme

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

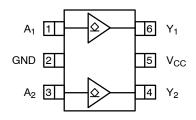


Figure 2. SC-88 (Top View)

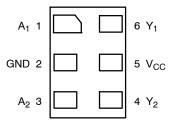
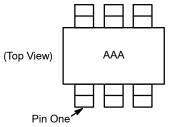


Figure 3. MicroPak (Top Through View)



NOTES:

- AAA represents product code top mark (see Ordering Information).
 Orientation of top mark determines pin one location.
 Read the top mark left to right, pin one is the lower left pin.

Figure 4. Pin 1 Orientation

PIN DEFINITIONS

| Pin # SC-88 | Pin # MicroPak | Name | Description |
|-------------|----------------|-----------------|----------------|
| 1 | 1 | A ₁ | Input |
| 2 | 2 | GND | Ground |
| 3 | 3 | A ₂ | Input |
| 4 | 4 | Y ₂ | Output |
| 5 | 5 | V _{CC} | Supply Voltage |
| 6 | 6 | Y ₁ | Output |

FUNCTION TABLE (Y = A)

| Inputs | Output |
|------------------|--|
| Α | Υ |
| LOW Logic Level | LOW Logic Level |
| HIGH Logic Level | HIGH Impedance Output State, Open Drain |

ABSOLUTE MAXIMUM RATINGS

| Symbol | Paramete | Min | Max | Unit | |
|-------------------------------------|--------------------------------------|---------------------------|------|------|----|
| V _{CC} | Supply Voltage | | -0.5 | 6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 | 6.5 | V |
| V _{OUT} | DC Output Voltage | | -0.5 | 6.5 | ٧ |
| I _{IK} | DC Input Diode Current | V _{IN} < -0.5 V | - | -50 | mA |
| I _{OK} | DC Output Diode Current | V _{OUT} < -0.5 V | - | -50 | mA |
| I _{OUT} | DC Output Current | - | ±50 | mA | |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current | | - | ±100 | mA |
| T _{STG} | Storage Temperature Range | | -65 | +150 | °C |
| TJ | Junction Temperature Under Bias | | - | +150 | °C |
| T _L | Junction Lead Temperature (Solderin | ig, 10 Seconds) | - | +260 | °C |
| P_{D} | Power Dissipation in Still Air | SC-88-6 | - | 190 | mW |
| | | MicroPak-6 | - | 327 | |
| | | MicroPak2™-6 | - | 327 | |
| ESD | Human Body Model, JEDEC: JESD22-A114 | | - | 4000 | V |
| | Charge Device Model, JEDEC: JESE |)22-C101 | - | 2000 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------------------|-------------------------------|--|------|------|------|
| V _{CC} | Supply Voltage Operating | | 1.65 | 5.50 | V |
| | Supply Voltage Data Retention | | 1.5 | 5.5 | |
| V _{IN} | Input Voltage | | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | | 0 | 5.5 | V |
| t _r , t _f | Input Rise and Fall Times | V _{CC} at 1.8 V ±0.15 V, 2.5 V ±0.2 V | 0 | 20 | ns/V |
| | | V _{CC} at 3.3 V ±0.3 V | 0 | 10 | |
| | | V _{CC} at 5.0 V ±0.5 V | 0 | 5 | |
| T _A | Operating Temperature | | -40 | +85 | °C |
| $\theta_{\sf JA}$ | Thermal Resistance | SC-88-6 | - | 659 | °C/W |
| | | MicroPak-6 | - | 382 | |
| | | MicroPak2-6 | - | 382 | |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs must be held HIGH or LOW. They may not float.

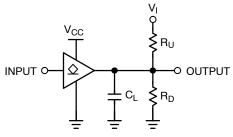
DC ELECTICAL CHARACTERISTICS

| | | | | T _A = +25°C | | | T _A = -40 to +85°C | | |
|------------------|--------------------------------------|---------------------|--|------------------------|------|----------------------|-------------------------------|----------------------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit |
| V _{IH} | HIGH Level Input Voltage | 1.65 to 1.95 | | 0.65 V _{CC} | - | - | 0.65 V _{CC} | _ | V |
| | | 2.30 to 5.50 | | 0.70 V _{CC} | - | - | 0.70 V _{CC} | _ | |
| V _{IL} | LOW Level Input Voltage | 1.65 to 1.95 | | - | - | 0.35 V _{CC} | - | 0.35 V _{CC} | V |
| | | 2.30 to 5.50 | | - | - | 0.30 V _{CC} | - | 0.30 V _{CC} | |
| I _{LKG} | HIGH Level Output Leakage Current | 1.65 to 1.95 | $V_{IN} = V_{IH},$ $V_{OUT} = V_{CC}$ or GND | - | - | ±5 | - | ±10 | μΑ |
| V _{OL} | LOW Level Output Voltage | 1.65 | $\begin{aligned} V_{IN} &= V_{IL}, \\ I_{OL} &= 100 \ \mu A \end{aligned}$ | - | 0.00 | 0.10 | - | 0.00 | V |
| | | 1.80 | | - | 0.00 | 0.10 | - | 0.10 | |
| | | 2.30 | | - | 0.00 | 0.10 | - | 0.10 | |
| | | 3.00 | | = | 0.00 | 0.10 | - | 0.10 | |
| | | 4.50 | | = | 0.00 | 0.10 | - | 0.10 |] |
| | | 1.65 | I _{OL} = 4 mA | - | 0.80 | 0.24 | - | 0.24 |] |
| | | 2.30 | I _{OL} = 8 mA | - | 0.10 | 0.30 | - | 0.30 |] |
| | | 3.00 | I _{OL} = 16 mA | - | 0.16 | 0.40 | - | 0.40 | |
| | | 3.00 | I _{OL} = 24 mA | - | 0.24 | 0.55 | - | 0.55 |] |
| | | 4.50 | I _{OL} = 32 mA | - | 0.25 | 0.55 | - | 0.55 |] |
| I _{IN} | Input Leakage Current | 1.65 to 5.5 | $0 \leq V_{IN} \leq 5.5 \ V$ | - | - | ±0.1 | - | ±10 | μΑ |
| I _{OFF} | Power Off Leakage Current | 0 | V_{IN} or $V_{OUT} = 5.5 V$ | _ | - | 1 | - | 10 | μΑ |
| I _{CC} | Quiescent Supply Current | 1.65 to 5.50 | V _{IN} = 5.5 V, GND | - | - | 1 | - | 10 | μΑ |

AC ELECTRICAL CHARACTERISTICS

| | | | | T _A = +25°C | | ; | $T_A = -40$ | to +85°C | | |
|-------------------------------------|-------------------------------|---------------------|---|------------------------|-----|------|-------------|----------|------|--|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit | |
| t _{PZL} , t _{PLZ} | Propagation Delay | 1.65 | C _L = 50 pF, | - | 6.6 | 11.5 | - | 12.6 | ns | |
| | (Figure 5, 6) | 1.80 | RU = 500 Ω , RD = 500 Ω , | = | 5.5 | 9.5 | - | 10.5 | | |
| | | 2.50 ±0.20 | $V_I = 2 \times V_{CC}$ | _ | 3.7 | 5.8 | - | 6.4 | | |
| | | 3.30 ±0.30 | | _ | 2.9 | 4.4 | - | 4.8 | | |
| | | 5.00 ±0.50 | | _ | 2.3 | 3.5 | - | 3.9 | | |
| | | 1.65 | C _L = 50 pF, | _ | 5.5 | 11.5 | - | 12.6 | | |
| | | 1.80 | RU = 500Ω , RD = 500Ω , $V_I = 2 \times V_{CC}$ | , | _ | 4.3 | 9.5 | - | 10.5 | |
| | | 2.50 ±0.20 | | _ | 2.8 | 5.8 | - | 6.4 | | |
| | | 3.30 ±0.30 | | _ | 2.1 | 4.4 | - | 4.8 | | |
| | | 5.00 ±0.50 | | _ | 1.4 | 3.5 | - | 3.9 | | |
| C _{IN} | Input Capacitance | 0 | | - | 2.5 | - | - | - | pF | |
| C _{OUT} | Output Capacitance | 0 | | _ | 4.0 | - | - | - | pF | |
| C _{PD} | Power Dissipation Capacitance | 3.30 | | _ | 3 | - | - | - | pF | |
| | (Note 5) (Figure 7) | | 1 | _ | 4 | - | - | _ | | |

^{5.} C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).



NOTE:

- 6. C_L includes load and stray capacitance. 7. Input PRR = 1.0 MHz, t_W = 500 ns.

Figure 5. AC Test Circuit

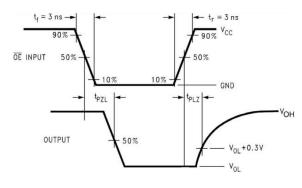
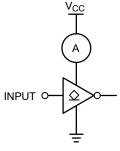


Figure 6. AC Waveforms



NOTE:

8. Input = AC Waveform; $t_r = t_f = 1.8 \text{ ns}$; PRR = Variable; Duty Cycle = 50%.

Figure 7. I_{CCD} Test Circuit

ORDERING INFORMATION

| Part Number | Top Mark | Package | Shipping [†] |
|-------------|----------|-----------|-----------------------|
| NC7WZ07P6X | Z07 | SC-88 | 3000 / Tape & Reel |
| NC7WZ07L6X | D3 | MicroPak | 5000 / Tape & Reel |
| NC7WZ07FHX | D3 | MicroPak2 | 5000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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NOTES:

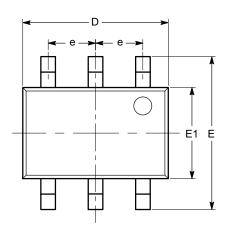
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- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
 4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

 - OTHER LINE IN THE MARK CODE LAYOUT.

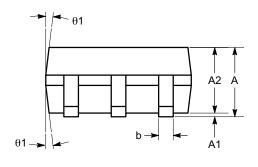
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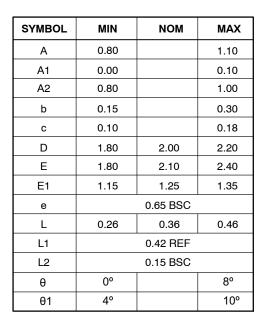
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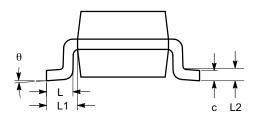


TOP VIEW



SIDE VIEW





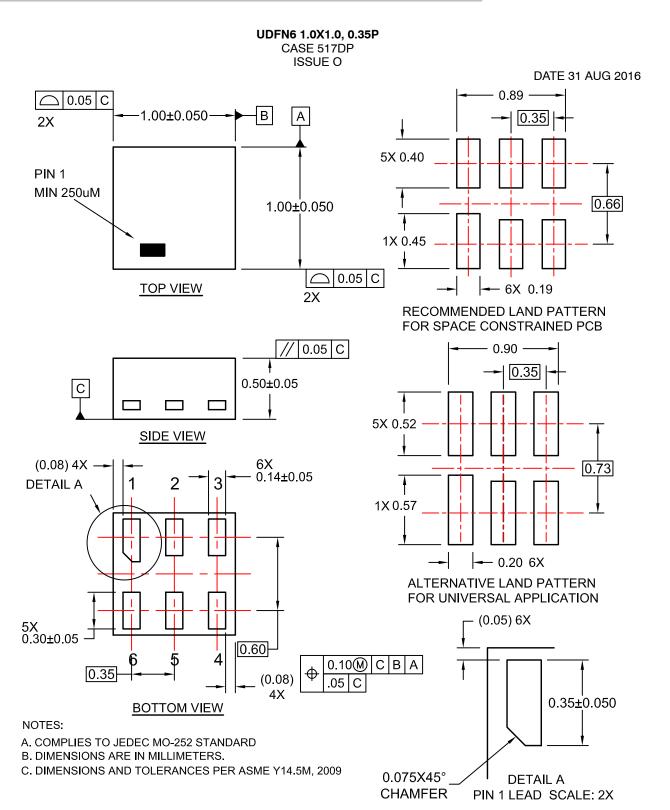
END VIEW

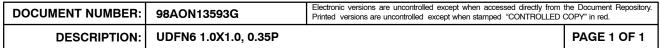
Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

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